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What is "Embedded - Microcontrollers"?

"Embedded - Microcontrollers" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

Applications of "Embedded - Microcontrollers"

Details	
Product Status	Discontinued at Digi-Key
Core Processor	ARM® Cortex®-M0
Core Size	32-Bit Single-Core
Speed	50MHz
Connectivity	EBI/EMI, I²C, IrDA, SPI, UART/USART
Peripherals	Brown-out Detect/Reset, DMA, I²S, LVD, POR, PS2, PWM, WDT
Number of I/O	49
Program Memory Size	128KB (128K x 8)
Program Memory Type	FLASH
EEPROM Size	-
RAM Size	16K x 8
Voltage - Supply (Vcc/Vdd)	2.5V ~ 5.5V
Data Converters	A/D 8x12b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	64-LQFP
Supplier Device Package	64-LQFP (10x10)
Purchase URL	https://www.e-xfl.com/product-detail/nuvoton-technology-corporation-america/nuc100re3an

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- NVIC that features:
  - 32 external interrupt inputs, each with four levels of priority
  - Dedicated Non-Maskable Interrupt (NMI) input.
  - Support for both level-sensitive and pulse-sensitive interrupt lines
  - Wake-up Interrupt Controller (WIC), providing ultra-low power sleep mode support.
- Debug support
  - Four hardware breakpoints.
  - Two watchpoints.
  - Program Counter Sampling Register (PCSR) for non-intrusive code profiling.
  - Single step and vector catch capabilities.
- Bus interfaces:
  - Single 32-bit AMBA-3 AHB-Lite system interface that provides simple integration to all system peripherals and memory.
  - Single 32-bit slave port that supports the DAP (Debug Access Port).

Address Space	Token	Controllers
0x400E_0000 – 0x400E_FFFF	ADC_BA	Analog-Digital-Converter (ADC) Control Registers
APB2 Controllers Space (0x4010_0000 ~ 0x401F_FFFF)		
0x4010_0000 – 0x4010_3FFF	PS2_BA	PS/2 Interface Control Registers
0x4011_0000 – 0x4011_3FFF	TMR23_BA	Timer2/Timer3 Control Registers
0x4012_0000 – 0x4012_3FFF	I2C1_BA	I^2C1 Interface Control Registers
0x4013_0000 – 0x4013_3FFF	SPI2_BA	SPI2 with master/slave function Control Registers (NuMicro™ NUC100/NUC120 Medium Density Only)
0x4013_4000 – 0x4013_7FFF	SPI3_BA	SPI3 with master/slave function Control Registers (NuMicro™ NUC100/NUC120 Medium Density Only)
0x4014_0000 – 0x4014_3FFF	PWMB_BA	PWM4/5/6/7 Control Registers (NuMicro™ NUC100/NUC120 Medium Density Only)
0x4015_0000 – 0x4015_3FFF	UART1_BA	UART1 Control Registers
0x4015_4000 – 0x4015_7FFF	UART2_BA	UART2 Control Registers (NuMicro™ NUC100/NUC120 Medium Density Only)
0x401A_0000 – 0x401A_3FFF	I2S_BA	I^2S Interface Control Registers
System Controllers Space (0xE000_E000 ~ 0xE000_EFFF)		
0xE000_E010 – 0xE000_E0FF	SCS_BA	System Timer Control Registers
0xE000_E100 – 0xE000_ECFF	SCS_BA	External Interrupt Controller Control Registers
0xE000_ED00 – 0xE000_ED8F	SCS_BA	System Control Registers

Table 5-1 Address Space Assignments for On-Chip Controllers

5.2.6.1 Exception Model and System Interrupt Map

Table 5-2 lists the exception model supported by NuMicro™ NUC100 Series. Software can set four levels of priority on some of these exceptions as well as on all interrupts. The highest user-configurable priority is denoted as “0” and the lowest priority is denoted as “3”. The default priority of all the user-configurable interrupts is “0”. Note that priority “0” is treated as the fourth priority on the system, after three system exceptions “Reset”, “NMI” and “Hard Fault”.

Exception Name	Vector Number	Priority
Reset	1	-3
NMI	2	-2
Hard Fault	3	-1
Reserved	4 ~ 10	Reserved
SVCall	11	Configurable
Reserved	12 ~ 13	Reserved
PendSV	14	Configurable
SysTick	15	Configurable
Interrupt (IRQ0 ~ IRQ31)	16 ~ 47	Configurable

Table 5-2 Exception Model

Vector Number	Interrupt Number (Bit in Interrupt Registers)	Interrupt Name	Source IP	Interrupt description
0 ~ 15	-	-	-	System exceptions
16	0	**BOD_OUT**	Brown-Out	Brown-Out low voltage detected interrupt
17	1	**WDT_INT**	WDT	Watchdog Timer interrupt
18	2	**EINT0**	GPIO	External signal interrupt from PB.14 pin
19	3	**EINT1**	GPIO	External signal interrupt from PB.15 pin
20	4	**GPAB_INT**	GPIO	External signal interrupt from PA[15:0]/PB[13:0]
21	5	**GPCDE_INT**	GPIO	External interrupt from PC[15:0]/PD[15:0]/PE[15:0]
22	6	**PWMA_INT**	PWM0~3	PWM0, PWM1, PWM2 and PWM3 interrupt
23	7	**PWMB_INT**	PWM4~7	PWM4, PWM5, PWM6 and PWM7 interrupt
24	8	**TMR0_INT**	TMR0	Timer 0 interrupt
25	9	**TMR1_INT**	TMR1	Timer 1 interrupt

5.3 Clock Controller

5.3.1 Overview

The clock controller generates the clocks for the whole chip, including system clocks and all peripheral clocks. The clock controller also implements the power control function with the individually clock ON/OFF control, clock source selection and a clock divider. The chip will not enter power down mode until CPU sets the power down enable bit (PWR_DOWN_EN) and Cortex-M0 core executes the WFI instruction. After that, chip enter power down mode and wait for wake-up interrupt source triggered to leave power down mode. In the power down mode, the clock controller turns off the external 4~24 MHz high speed crystal and internal 22.1184 MHz high speed oscillator to reduce the overall system power consumption.

5.3.4 Peripherals Clock

The peripherals clock had different clock source switch setting which depends on the different peripheral. Please refer the CLKSEL1 and CLKSEL2 register description in 5.3.7.

5.3.5 Power Down Mode Clock

When chip enters into power down mode, system clocks, some clock sources, and some peripheral clocks will be disabled. Some clock sources and peripherals clock are still active in power down mode.

For theses clocks which still keep active list below:

- Clock Generator
  - Internal 10 kHz low speed oscillator clock
  - External 32.768 kHz low speed crystal clock
- Peripherals Clock (When WDT adopt internal 10 kHz low speed oscillator as clock source and RTC adopt external 32.768 kHz low speed crystal as clock source)

5.7 Real Time Clock (RTC)

5.7.1 Overview

Real Time Clock (RTC) controller provides user the real time and calendar message. The clock source of RTC is from an external 32.768 kHz low speed crystal connected at pins X32I and X32O (reference to pin descriptions) or from an external 32.768 kHz low speed oscillator output fed at pin X32I. The RTC controller provides the time message (second, minute, hour) in Time Loading Register (TLR) as well as calendar message (day, month, year) in Calendar Loading Register (CLR). The data message is expressed in BCD format. It also offers alarm function that user can preset the alarm time in Time Alarm Register (TAR) and alarm calendar in Calendar Alarm Register (CAR).

The RTC controller supports periodic Time Tick and Alarm Match interrupts. The periodic interrupt has 8 period options 1/128, 1/64, 1/32, 1/16, 1/8, 1/4, 1/2 and 1 second which are selected by TTR (TTR[2:0]). When RTC counter in TLR and CLR is equal to alarm setting time registers TAR and CAR, the alarm interrupt flag (RIIR.AIF) is set and the alarm interrupt is requested if the alarm interrupt is enabled (RIER.AIER=1). Both RTC Time Tick and Alarm Match can cause chip wake-up from power down mode if wake-up function is enabled (TWKE (TTR[3])=1).

5.7.2 Features

- There is a time counter (second, minute, hour) and calendar counter (day, month, year) for user to check the time
- Alarm register (second, minute, hour, day, month, year)
- 12-hour or 24-hour mode is selectable
- Leap year compensation automatically
- Day of week counter
- Frequency compensate register (FCR)
- All time and calendar message is expressed in BCD code
- Support periodic time tick interrupt with 8 period options 1/128, 1/64, 1/32, 1/16, 1/8, 1/4, 1/2 and 1 second
- Support RTC Time Tick and Alarm Match interrupt
- Support wake-up chip from power down mode

6 FLASH MEMORY CONTROLLER (FMC)

6.1 Overview

NuMicro™ NUC100 Series equips with 128/64/32K bytes on chip embedded Flash for application program memory (APROM) that can be updated through ISP procedure. In System Programming (ISP) function enables user to update program memory when chip is soldered on PCB. After chip power on, Cortex-M0 CPU fetches code from APROM or LDROM decided by boot select (CBS) in Config0. By the way, NuMicro™ NUC100 Series also provides additional DATA Flash for user, to store some application dependent data before chip power off. For 128K bytes APROM device, the data flash is shared with original 128K program memory and its start address is configurable and defined by user application request in Config1. For 64K/32K bytes APROM device, the data flash is fixed at 4K.

6.2 Features

- Run up to 50 MHz with zero wait state for continuous address read access
- 128/64/32KB application program memory (APROM) (NuMicro™ NUC100/NUC120 Low Density only support up to 64KB size)
- 4KB in system programming (ISP) loader program memory (LDROM)
- Configurable or fixed 4KB data flash with 512 bytes page erase unit
- Programmable data flash start address for 128K APROM device
- In System Program (ISP) to update on chip Flash

7 ELECTRICAL CHARACTERISTICS

7.1 Absolute Maximum Ratings

SYMBOL	PARAMETER	MIN	MAX	UNIT
DC Power Supply	V_{DD}–V_{SS}	-0.3	+7.0	V
Input Voltage	V_{IN}	V_{SS}-0.3	V_{DD}+0.3	V
Oscillator Frequency	$1/t_{CLCL}$	4	24	MHz
Operating Temperature	TA	-40	+85	°C
Storage Temperature	TST	-55	+150	°C
Maximum Current into V_{DD}		-	120	mA
Maximum Current out of V_{SS}			120	mA
Maximum Current sunk by a I/O pin			35	mA
Maximum Current sourced by a I/O pin			35	mA
Maximum Current sunk by total I/O pins			100	mA
Maximum Current sourced by total I/O pins			100	mA

Note: Exposure to conditions beyond those listed under absolute maximum ratings may adversely affects the lift and reliability of the device.

PARAMETER	SYM.	SPECIFICATION				TEST CONDITIONS
		MIN.	TYP.	MAX.	UNIT	
	I_{DD8}		12		mA	V_{DD} = 3 V@12 MHz, disable all IP and disable PLL, XTAL=12 MHz
Operating Current Normal Run Mode @ 4 MHz	I_{DD9}		15		mA	V_{DD} = 5 V@4 MHz, enable all IP and disable PLL, XTAL=4 MHz
	I_{DD10}		11		mA	V_{DD} = 5 V@4 MHz, disable all IP and disable PLL, XTAL=4 MHz
	I_{DD11}		13		mA	V_{DD} = 3 V@4 MHz, enable all IP and disable PLL, XTAL=4 MHz
	I_{DD12}		9		mA	V_{DD} = 3 V@4 MHz, disable all IP and disable PLL, XTAL=4 MHz
Operating Current Idle Mode @ 50 MHz	I_{IDLE1}		38		mA	V_{DD}= 5.5 V@50 MHz, enable all IP and PLL, XTAL=12 MHz
	I_{IDLE2}		15		mA	VDD=5.5 V@50 MHz, disable all IP and enable PLL, XTAL=12 MHz
	I_{IDLE3}		35		mA	V_{DD} = 3 V@50 MHz, enable all IP and PLL, XTAL=12 MHz
	I_{IDLE4}		13		mA	V_{DD} = 3 V@50 MHz, disable all IP and enable PLL, XTAL=12 MHz
Operating Current Idle Mode @ 12 MHz	I_{IDLE5}		13		mA	V_{DD} = 5.5 V@12 MHz, enable all IP and disable PLL, XTAL=12 MHz
	I_{IDLE6}		5.5		mA	V_{DD} = 5.5 V@12 MHz, disable all IP and disable PLL, XTAL=12 MHz
	I_{IDLE7}		12		mA	V_{DD} = 3 V@12 MHz, enable all IP and disable PLL, XTAL=12 MHz

Note:

1. /RESET pin is a Schmitt trigger input.

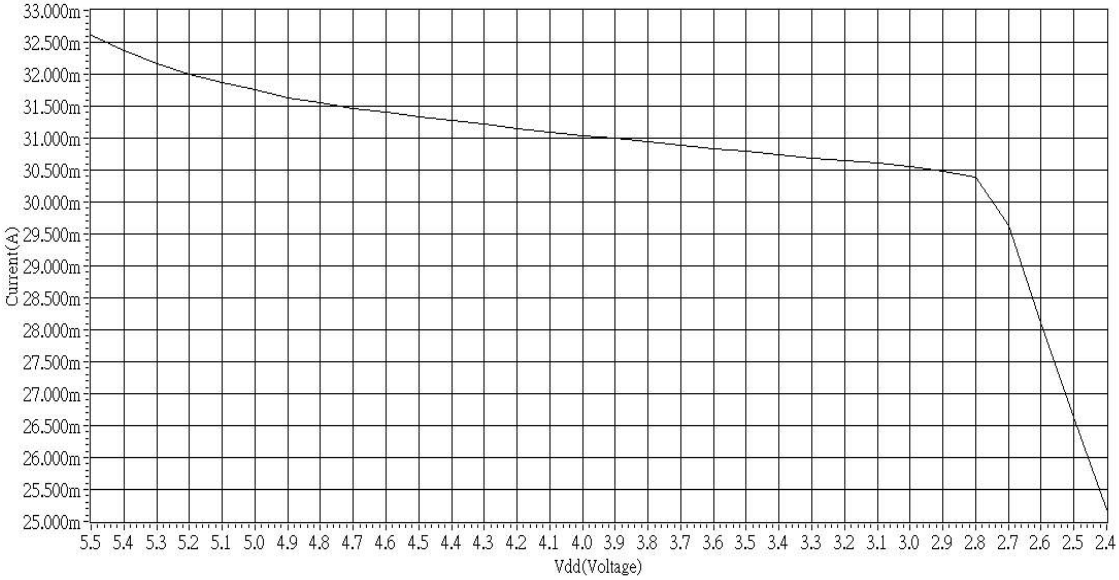
2. Crystal Input is a CMOS input.

3. Pins of PA, PB, PC, PD and PE can source a transition current when they are being externally driven from 1 to 0. In the condition of V_{DD}=5.5 V, 5he transition current reaches its maximum value when V_{IN} approximates to 2 V.

PARAMETER	SYM.	SPECIFICATION				TEST CONDITIONS
		MIN.	TYP.	MAX.	UNIT	
	I_{DD8}		11.5		mA	V_{DD} = 3 V@12 MHz, disable all IP and disable PLL, XTAL=12 MHz
Operating Current Normal Run Mode @ 4 MHz	I_{DD9}		13.5		mA	V_{DD} = 5 V@4 MHz, enable all IP and disable PLL, XTAL=4 MHz
	I_{DD10}		10		mA	V_{DD} = 5 V@4 MHz, disable all IP and disable PLL, XTAL=4 MHz
	I_{DD11}		12		mA	V_{DD} = 3 V@4 MHz, enable all IP and disable PLL, XTAL=4 MHz
	I_{DD12}		8		mA	V_{DD} = 3 V@4 MHz, disable all IP and disable PLL, XTAL=4 MHz
Operating Current Idle Mode @ 50 MHz	I_{IDLE1}		30		mA	V_{DD}= 5.5 V@50 MHz, enable all IP and PLL, XTAL=12 MHz
	I_{IDLE2}		13		mA	VDD=5.5 V@50 MHz, disable all IP and enable PLL, XTAL=12 MHz
	I_{IDLE3}		28		mA	V_{DD} = 3 V@50 MHz, enable all IP and PLL, XTAL=12 MHz
	I_{IDLE4}		12		mA	V_{DD} = 3 V@50 MHz, disable all IP and enable PLL, XTAL=12 MHz
Operating Current Idle Mode @ 12 MHz	I_{IDLE5}		11		mA	V_{DD} = 5.5 V@12 MHz, enable all IP and disable PLL, XTAL=12 MHz
	I_{IDLE6}		5		mA	V_{DD} = 5.5 V@12 MHz, disable all IP and disable PLL, XTAL=12 MHz
	I_{IDLE7}		10		mA	V_{DD} = 3 V@12 MHz, enable all IP and disable PLL, XTAL=12 MHz

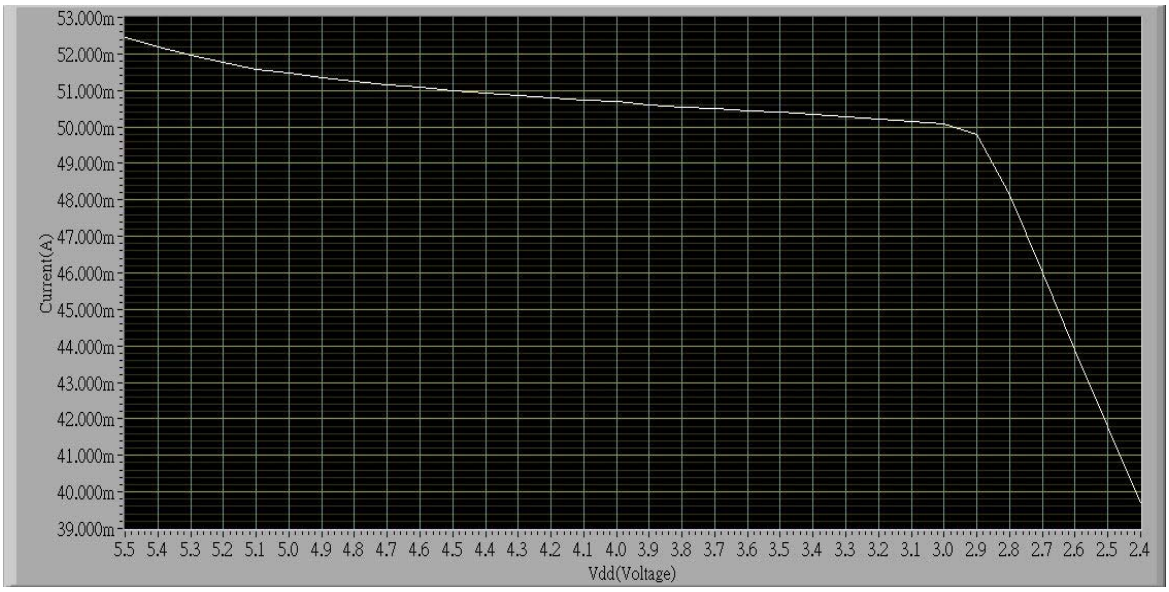
3. XTAL clock = 12 MHz, PLL enable, all-IP disable

Unit: mA

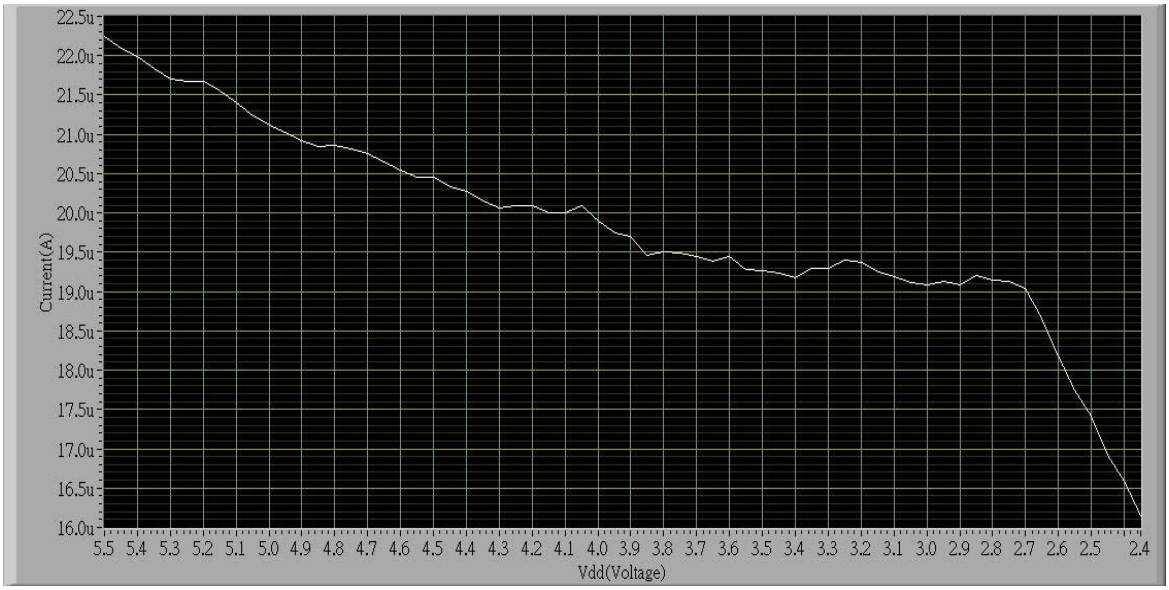


4. XTAL clock = 12 MHz, PLL enable, all-IP enable

Unit: mA



7.2.5 Power Down Current Curve

XTAL clock = 12 MHz, PLL Disable

Unit: mA